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To the Honorable Commissioner of Paten	ts and Trademarks. Ple	ease record the attached original documents or copy thereof.	
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(1) YUSUKE SEKI AND (2) AKIHI	KO KANDORI	Name - Historia High Taskuslasia Const.	
Additional names of conveying parties attached: ☐ Yes ☒ No		Name: Hitachi High-Technologies Corporation Address: 24-14, Nishi-Shimbashi 1-chome Minato-ku, Tokyo, Japan 105-8717	
3. Nature of Conveyance:			
□ Assignment □ Security Agreement □ Other:	U		
Execution Dates: (1) November 24 November 28, 2006	4, 2006 and (2)		
4. (a) Patent Application Number(s):			
11/545,461		4. (b) Patent Numbers:	
If this document is being filed together with a new application, the execution date of the application is:			
☐ Additional Numbers Attached.			
5. Name and Address of Party to whom Correspondence Concerning this Document Should be Mailed:		6. Total Number of Applications and Patents Involved: 1	
Name: Stanley P. Fisher		7. Total Fee: \$40.00 (37 C.F.R. § 3.41)	
Address: Reed Smith LLP 3110 Fairview Park I Suite 1400 Falls Church, VA 22		Enclosed. Authorized to be charged to deposit account.	
		8. Deposit Account Number: 08-1480	
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To the best of my knowledge and belief, the foregoing is true and correct and any attached copy is a true copy of the original document.			
	SH11	December 14, 2006	
Stanley P. Fisher, Registration No. 24, 34	1/ (Juan Carlos A. Marquez, Registration No. 34,072	
Total number of pages comprising cover sheet: 1			
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ASSIGNMENT

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Hitachi High-Technologies Corporation a corporation organized under the laws of Japan,

located at 24-14, Nishi-Shimbashi 1-chome, Minato-ku, Tokyo 105-8717, Japan

receipt of which is hereby acknowledged I do hereby sell and assign to said Hitachi High-Technologies Corporation its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

Magnetic Detection Coil and Apparatus for Measurement of Magnetic Field

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted,

to be held and enjoyed by said Hitachi High-Technologies Corporation

its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Hitachi High-Technologies Corporation

Signed on the date(s) indicated aside our signatures:

RECORDED: 12/14/2006

INVENTOR(S) (発明者フルネームサイン)	(署名日)
1) Yrsuhl Sehie-	[[] [24 20=6.
2) Akihiko Kandori	11/28/2006
3)	
4)	
5)	
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8)	
9)	
10)	

PATENT REEL: 018709 FRAME: 0598